

[54] SEMICONDUCTOR

[75] Inventors: **Hidetoshi Mochizuki**, Fuchu; **Keizo Otsuki**, Higashiyamayo; **Hideki Kosaka**, Kodaira; **Gen Murakami**, Machida, all of Japan

[73] Assignee: **Hitachi, Ltd.**, Tokyo, Japan

[**] Term: **14 Years**

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[30] Foreign Application Priority Data

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Aug. 25, 1978 [JP]	Japan	53-35730
Aug. 25, 1978 [JP]	Japan	53-35734
Aug. 25, 1978 [JP]	Japan	53-35738

[51] Int. Cl. **D13-03**

[52] U.S. Cl. **D13/99**

[58] Field of Search D13/12, 99, 40, 41; 174/52 R, 52 PE, 52 S, 52 FP, 50.5, 50.52, 50.56; 357/70, 73, 74, 80

[56] References Cited

U.S. PATENT DOCUMENTS

3,208,892	9/1965	Miller et al.	174/52 FP X
3,436,451	4/1969	Wasser	174/52 FP X
4,012,766	3/1977	Phillips et al.	174/52 FP X

OTHER PUBLICATIONS

Electronics, 3-17-1977, Front Cover, LSI Package (top right).

Electronics, 10-13-1977, p. 9, Semiconductor.

Electronics, 10-27-1977, p. 9, Integrated Circuit Package (square).

Electronics, 11-24-1977, p. 145, Integrated Circuit Package (bottom right).

Primary Examiner—Susan J. Lucas

Attorney, Agent, or Firm—Craig & Antonelli

[57] CLAIM

The ornamental design for a semiconductor, as shown and described.

DESCRIPTION

FIG. 1 is a right side, top and front perspective view of a semiconductor showing our new design;

FIG. 2 is a rear elevational view thereof;

FIG. 3 is a left side view thereof;

FIG. 4 is a bottom view thereof;

FIG. 5 is a right side, top and front perspective view of a semiconductor showing another embodiment of our new design;

FIG. 6 is a bottom view thereof;

FIG. 7 is a right side, top and front perspective view of a semiconductor showing another embodiment of our new design;

FIG. 8 is a bottom view thereof;

FIG. 9 is a right side, top and front perspective view of a semiconductor showing another embodiment of our new design;

FIG. 10 is a bottom view thereof.

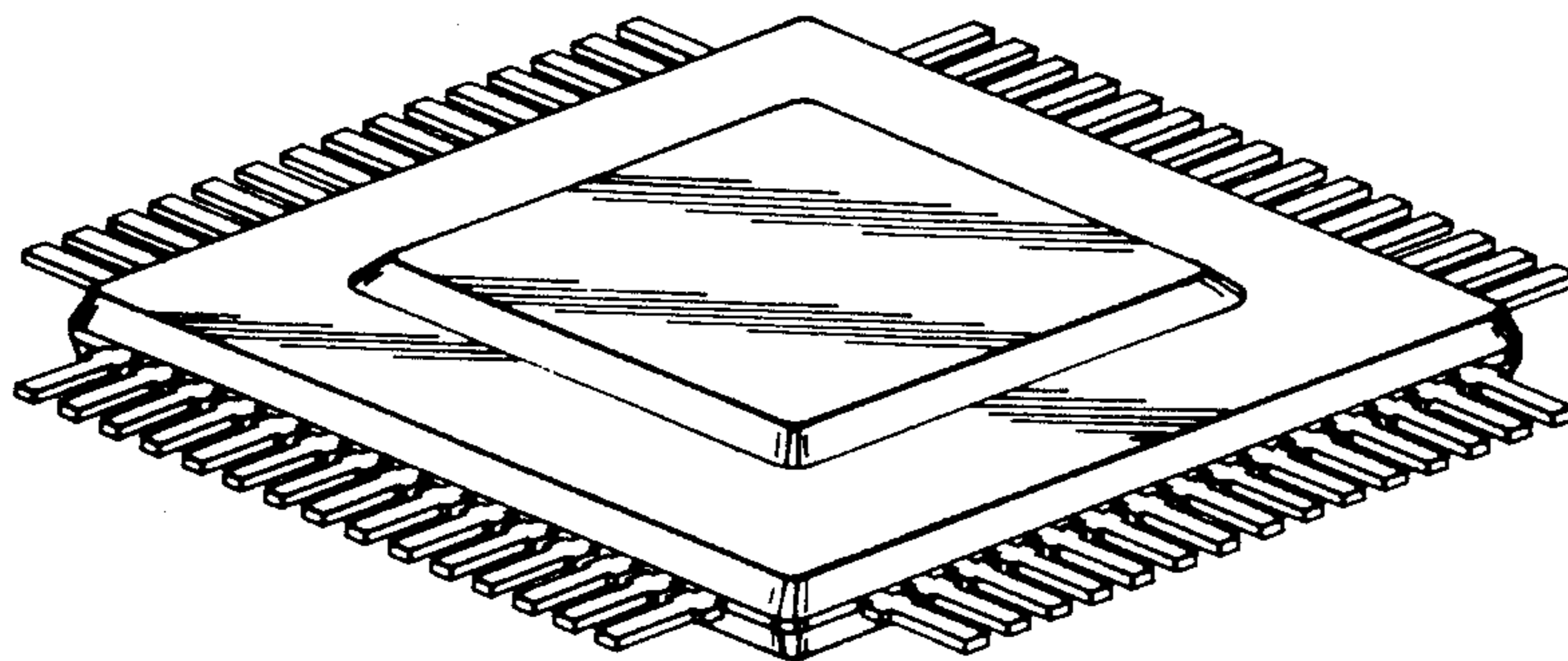


FIG. 1

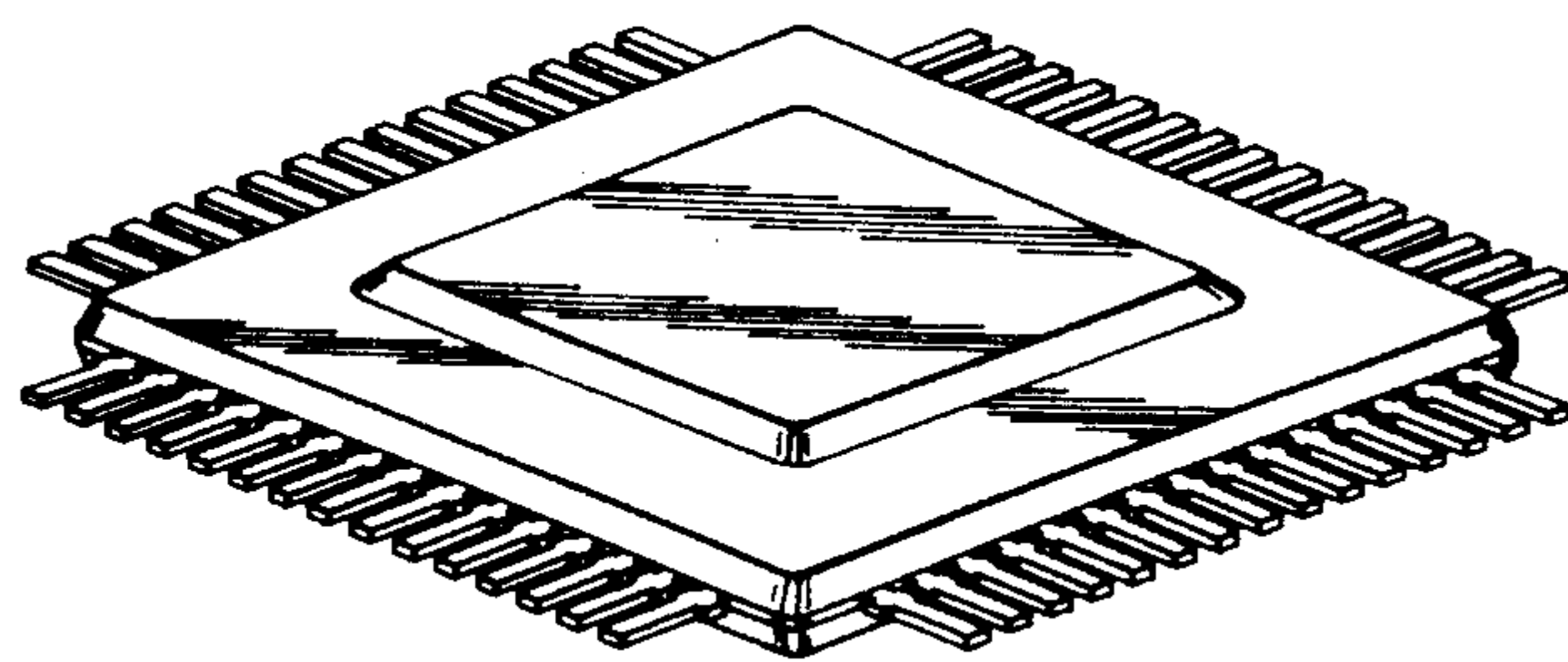


FIG. 2

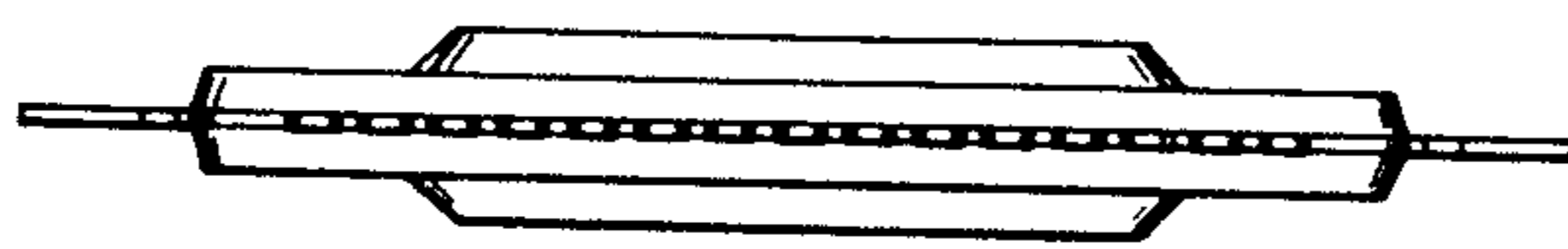


FIG. 3

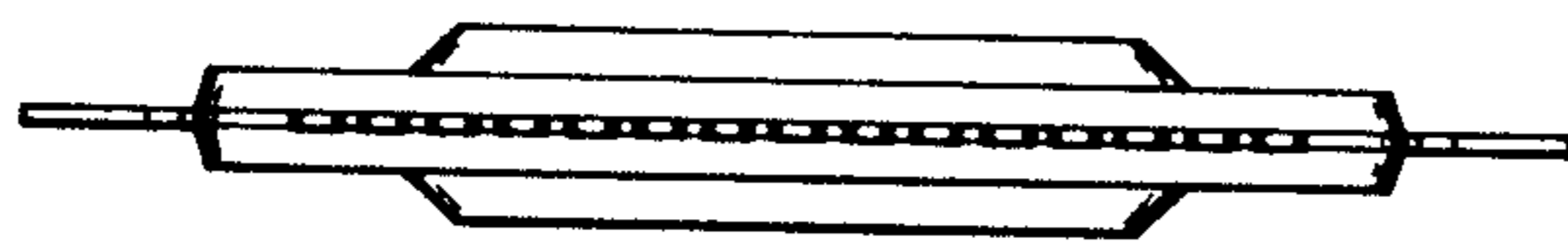


FIG. 4

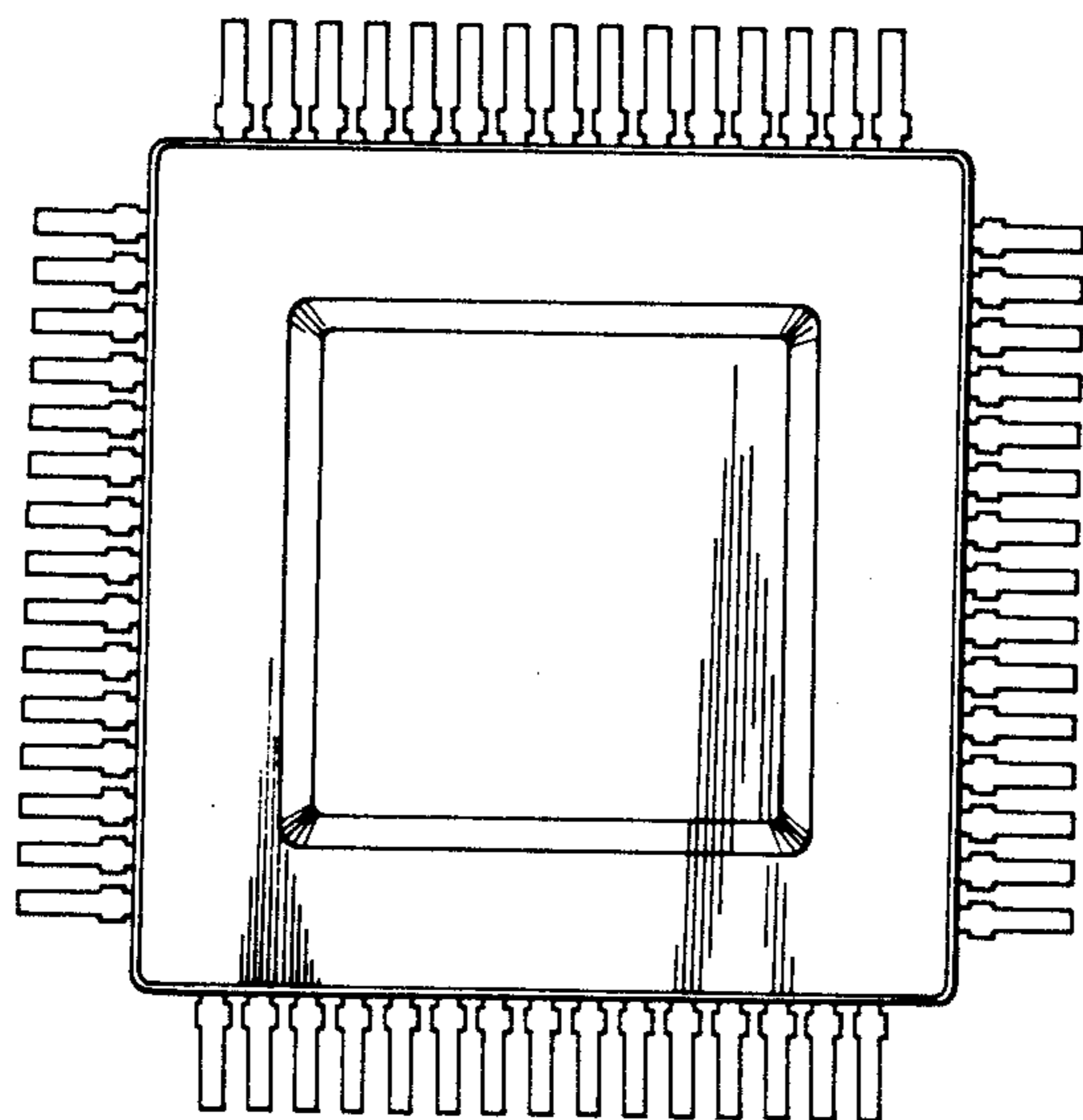


FIG. 7

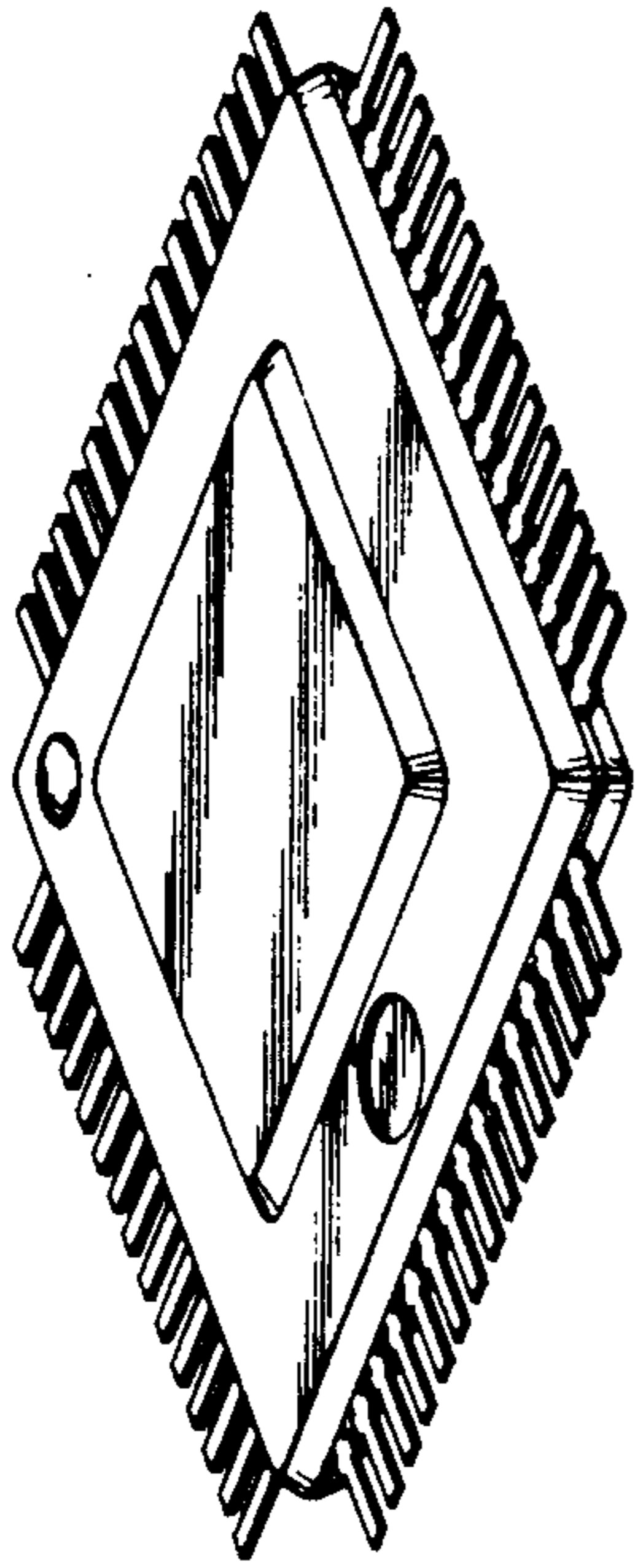


FIG. 8

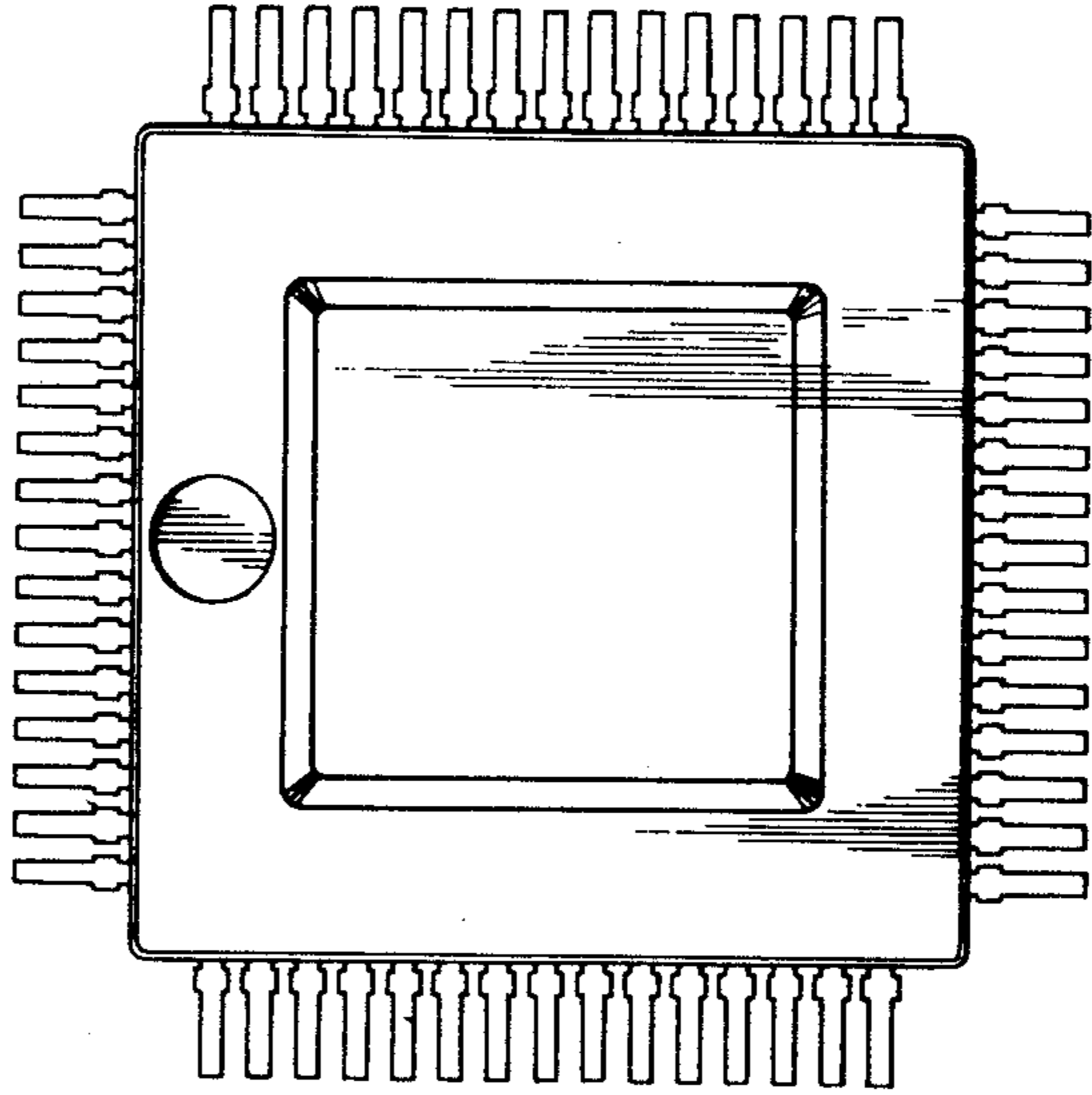


FIG. 5

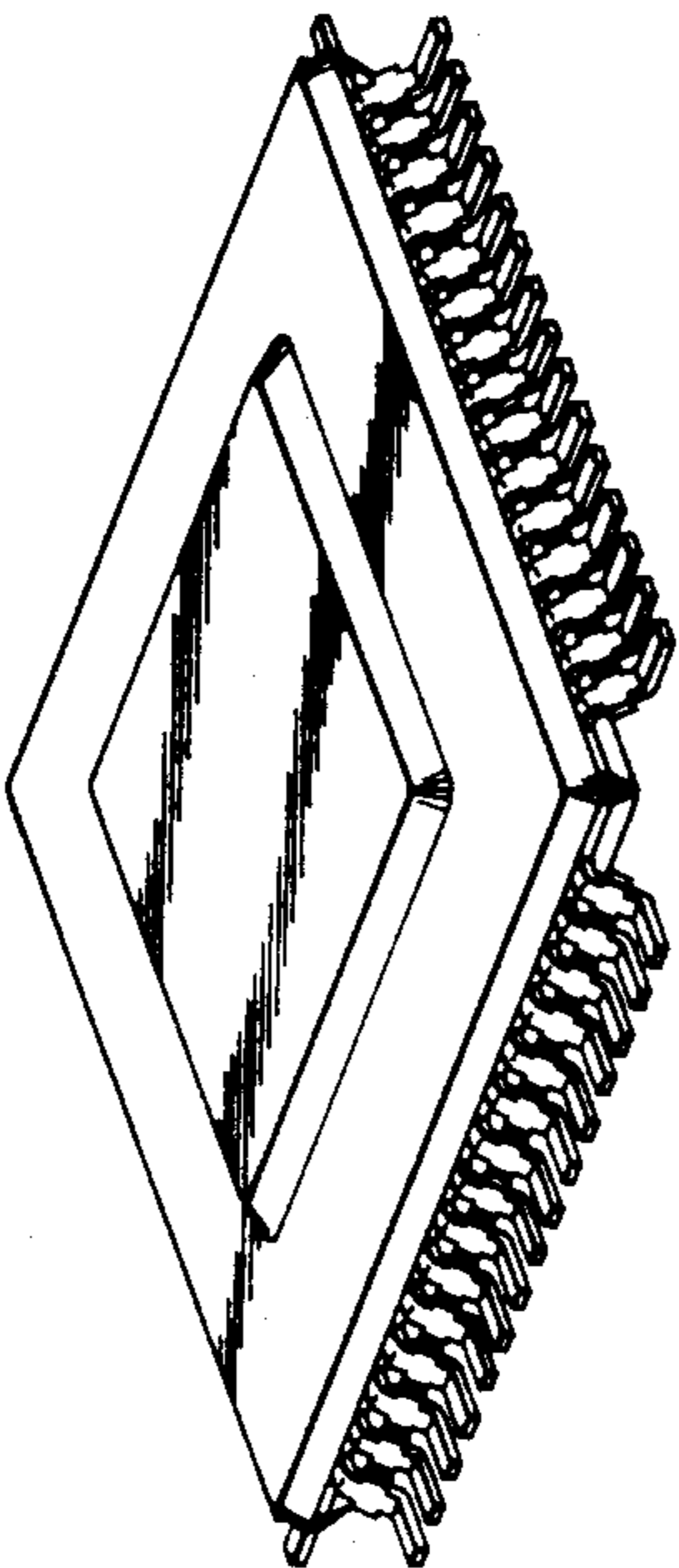


FIG. 6

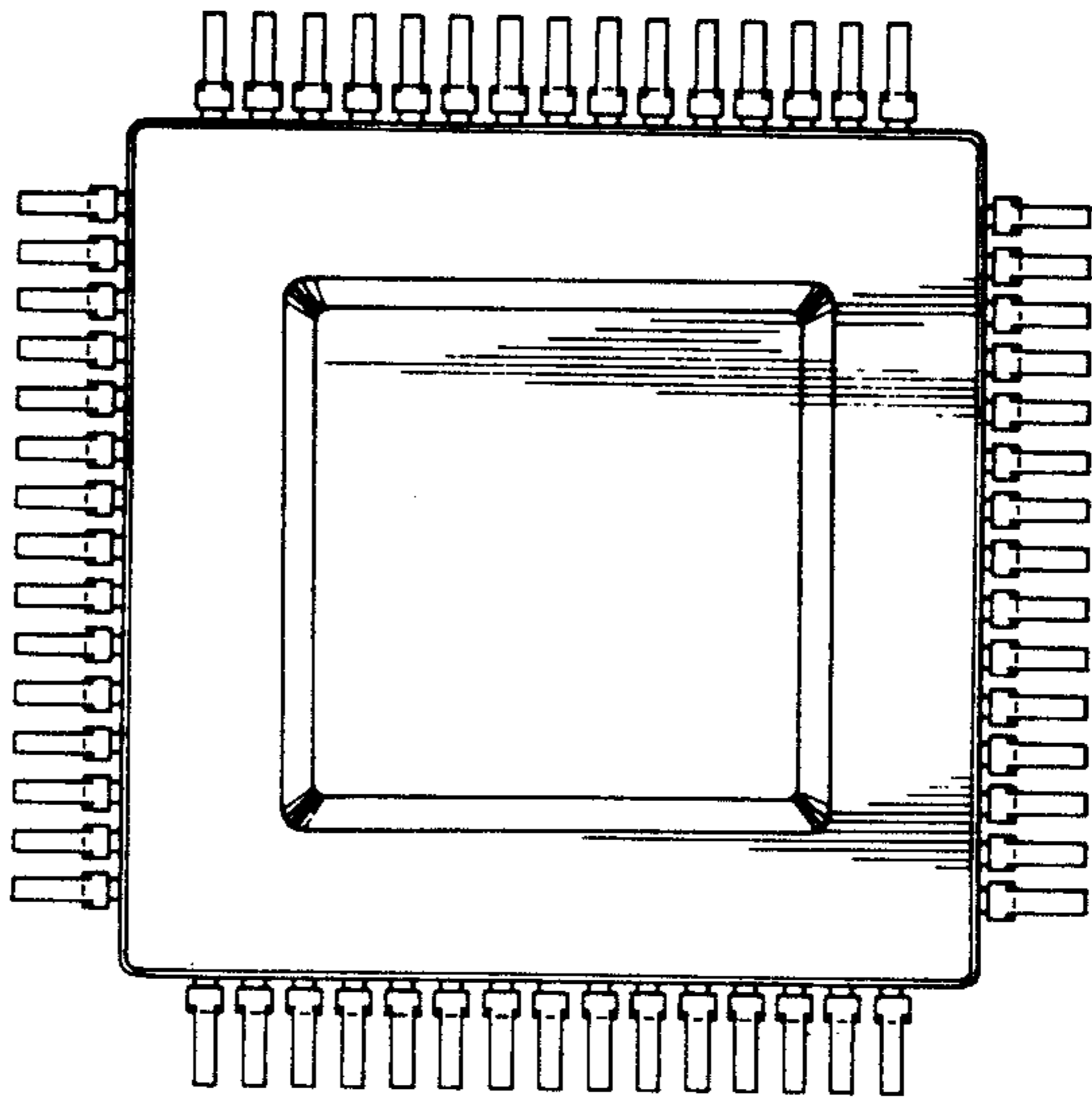


FIG. 9

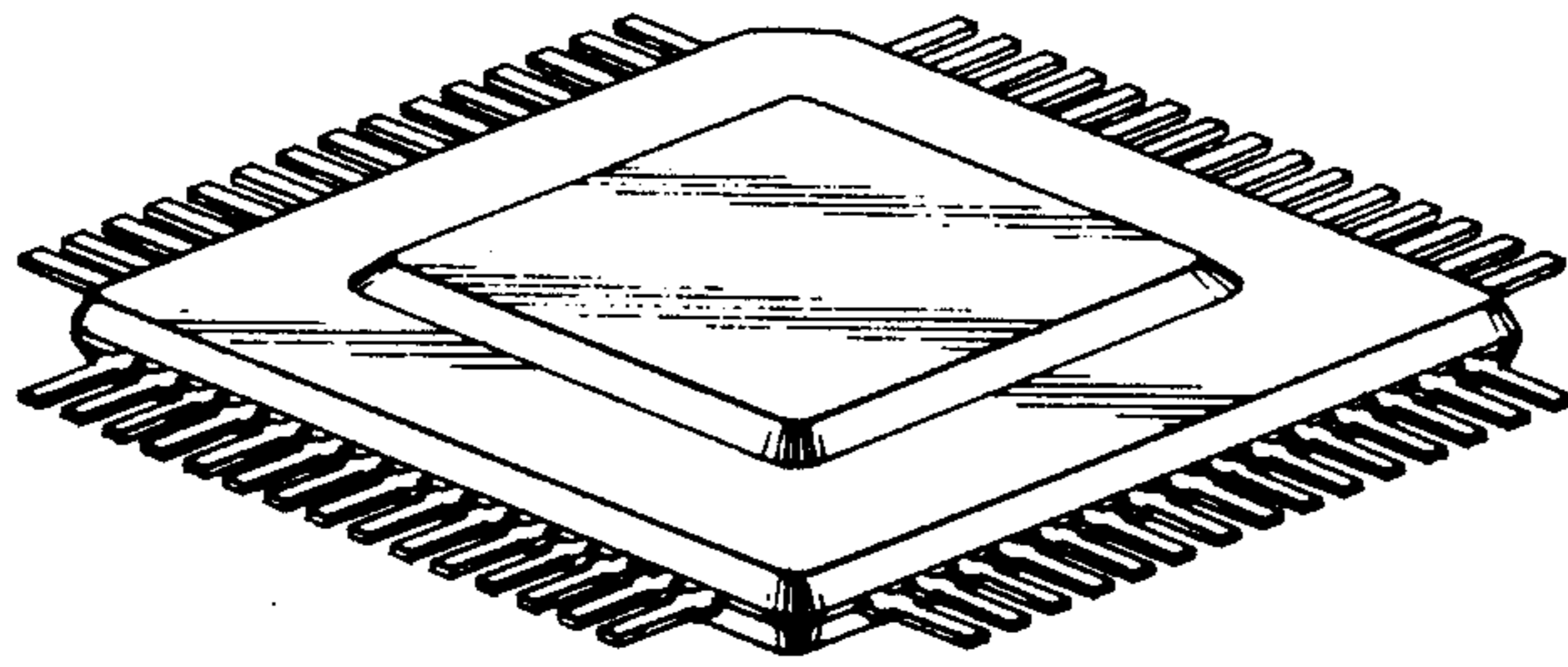


FIG. 10

